

2SK3537-01MR

FUJI
ELECTRIC

200304

FUJI POWER MOSFET Super FAP-G Series

N-CHANNEL SILICON POWER MOSFET

■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

■ Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

■ Maximum ratings and characteristic Absolute maximum ratings

● (Tc=25°C unless otherwise specified)

Item	Symbol	Ratings	Unit
Drain-source voltage	VDS	150	V
	VDSX *5	130	V
Continuous drain current	Id	±33	A
Pulsed drain current	Id(puls)	±132	A
Gate-source voltage	VGS	±20	V
Repetitive or non-repetitive	lAR *2	33	A
Maximum Avalanche Energy	EAS*1	169	mJ
Maximum Drain-Source dV/dt	dVds/dt *4	20	kV/μs
Peak Diode Recovery dV/dt	dV/dt *3	5	kV/μs
Max. power dissipation	PD	2.16	W
	Ta=25°C		
	Tc=25°C	53	
Operating and storage temperature range	Tch	+150	°C
	Tstg	-55 to +150	°C

*1 L=0.228mH, Vcc=48V, Tch=25°C, See to A valance Energy Graph *2 Tch≤150°C

*3 If=Id, -di/dt=50A/μs, Vcc≤BVDS, Tch≤150°C *4 Vds≤150V *5 VGS=-20V

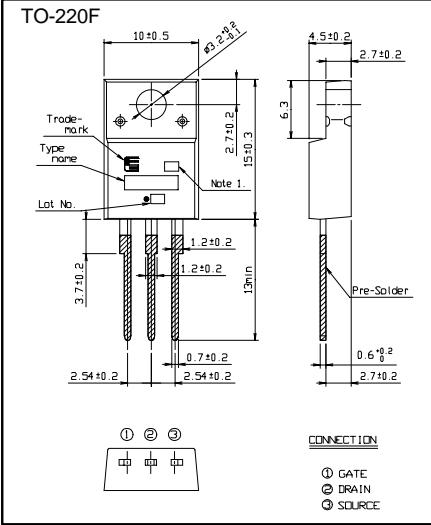
● Electrical characteristics (Tc =25°C unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	Id=250μA VGS=0V	150			V
Gate threshold voltage	VGS(th)	Id= 250μA Vds=VGS	1.0		2.5	V
Zero gate voltage drain current	IdSS	Vds=150V VGS=0V	Tch=25°C		25	μA
		Vds=120V VGS=0V			250	
Gate-source leakage current	IGSS	VGS=±20V Vds=0V		10	100	nA
Drain-source on-state resistance	RDS(on)	Id=11.5A	VGS=4V	65	90	mΩ
				60	81	
				54	70	
Forward transconductance	gfs	Id=11.5A Vds=25V	12	24		S
Input capacitance	Ciss	Vds=75V		1900	2850	pF
Output capacitance	Coss	VGS=0V		200	300	
Reverse transfer capacitance	Crss	f=1MHz		17	25.5	
Turn-on time ton	td(on)	Vcc=48V Id=11.5A		10	15	ns
	tr			15	23	
Turn-off time toff	td(off)	VGS=10V		85	128	
	tf	RGS=10 Ω		12	18	
Total Gate Charge	QG	Vcc=48V		46	70	nC
Gate-Source Charge	QGS	Id=23A		8	12	
Gate-Drain Charge	QGD	VGS=10V		12.5	19	
Avalanche capability	IAV	L=228μH Tch=25°C	33			A
Diode forward on-voltage	VSD	If=23A Vgs=0V Tch=25°C		1.10	1.65	V
Reverse recovery time	trr	If=23A Vgs=0V		0.13		μs
Reverse recovery charge	Qrr	-di/dt=100A/μs Tch=25°C		0.6		μC

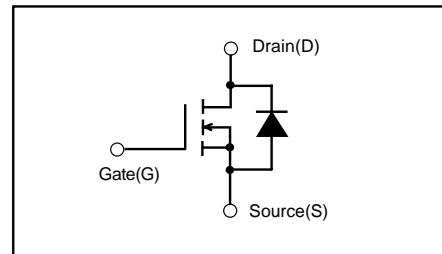
● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	Rth(ch-c)	channel to case			2.359	°C/W
	Rth(ch-a)	channel to ambient			58.0	°C/W

■ Outline Drawings [mm]



■ Equivalent circuit schematic



■ Characteristics

